



CYPRESS

CY7C1049V33

## 512K x 8 Static RAM

## Features

- High speed
  - $t_{AA} = 15$  ns
- Low active power
  - 504 mW (max.)
- Low CMOS standby power (Commercial L version)
  - 1.8 mW (max.)
- 2.0V Data Retention (660  $\mu$ W at 2.0V retention)
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with  $\overline{CE}$  and  $\overline{OE}$  features

## Functional Description

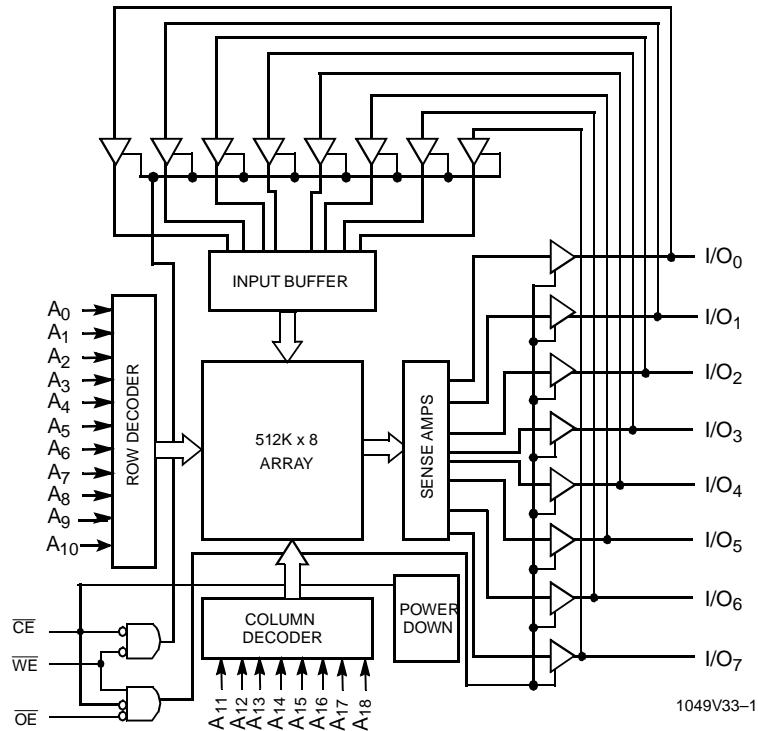
The CY7C1049V33 is a high-performance CMOS Static RAM organized as 524,288 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable ( $\overline{CE}$ ), an active LOW Output Enable ( $\overline{OE}$ ), and three-state drivers. Writing to the device is accomplished by taking Chip Enable ( $\overline{CE}$ ) and Write Enable ( $\overline{WE}$ ) inputs LOW. Data on the eight I/O pins ( $I/O_0$  through  $I/O_7$ ) is then written into the location specified on the address pins ( $A_0$  through  $A_{18}$ ).

Reading from the device is accomplished by taking Chip Enable ( $\overline{CE}$ ) and Output Enable ( $\overline{OE}$ ) LOW while forcing Write Enable ( $\overline{WE}$ ) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins ( $I/O_0$  through  $I/O_7$ ) are placed in a high-impedance state when the device is deselected ( $\overline{CE}$  HIGH), the outputs are disabled ( $\overline{OE}$  HIGH), or during a write operation ( $\overline{CE}$  LOW, and  $\overline{WE}$  LOW).

The CY7C1049V33 is available in a standard 400-mil-wide 36-pin SOJ package with center power and ground (revolutionary) pinout.

## Logic Block Diagram



## Pin Configuration

SOJ  
Top View

A <sub>0</sub>	1	36	NC
A <sub>1</sub>	2	35	A <sub>18</sub>
A <sub>2</sub>	3	34	A <sub>17</sub>
A <sub>3</sub>	4	33	A <sub>16</sub>
A <sub>4</sub>	5	32	A <sub>15</sub>
CE	6	31	$\overline{OE}$
I/O <sub>0</sub>	7	30	I/O <sub>7</sub>
I/O <sub>1</sub>	8	29	I/O <sub>6</sub>
V <sub>CC</sub>	9	28	GND
GND	10	27	V <sub>CC</sub>
I/O <sub>2</sub>	11	26	I/O <sub>5</sub>
I/O <sub>3</sub>	12	25	I/O <sub>4</sub>
WE	13	24	A <sub>14</sub>
A <sub>5</sub>	14	23	A <sub>13</sub>
A <sub>6</sub>	15	22	A <sub>12</sub>
A <sub>7</sub>	16	21	A <sub>11</sub>
A <sub>8</sub>	17	20	A <sub>10</sub>
A <sub>9</sub>	18	19	NC

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## Selection Guide

	1049V33-12	1049V33-15	1049V33-17	1049V33-20	1049V33-25
Maximum Access Time (ns)	12	15	17	20	25
Maximum Operating Current (mA)	150	140	130	120	110
Maximum CMOS Standby Current (mA)	Com'l/Ind'l	8	8	8	8
	Com'l	0.5	0.5	0.5	0.5

Shaded areas contain preliminary information.

## Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature .....  $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

Ambient Temperature with

Power Applied .....  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

Supply Voltage on  $V_{\text{CC}}$  to Relative GND<sup>[1]</sup> ....  $-0.5\text{V}$  to  $+4.6\text{V}$

DC Voltage Applied to Outputs  
in High Z State<sup>[1]</sup> .....  $-0.5\text{V}$  to  $V_{\text{CC}} + 0.5\text{V}$

DC Input Voltage<sup>[1]</sup> .....  $-0.5\text{V}$  to  $V_{\text{CC}} + 0.5\text{V}$

Current into Outputs (LOW) ..... 20 mA

## Operating Range

Range	Ambient Temperature <sup>[2]</sup>	$V_{\text{CC}}$
Commercial	$0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$	$3.3\text{V} \pm 0.3\text{V}$
Industrial	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	

## Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	7C1049V33-12		7C1049V33-15		7C1049V33-17		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
$V_{\text{OH}}$	Output HIGH Voltage	$V_{\text{CC}} = \text{Min.}$ , $I_{\text{OH}} = -4.0\text{ mA}$	2.4		2.4		2.4		V
$V_{\text{OL}}$	Output LOW Voltage	$V_{\text{CC}} = \text{Min.}$ , $I_{\text{OL}} = 8.0\text{ mA}$		0.4		0.4		0.4	V
$V_{\text{IH}}$	Input HIGH Voltage		2.2	$V_{\text{CC}} + 0.5$	2.2	$V_{\text{CC}} + 0.5$	2.2	$V_{\text{CC}} + 0.5$	V
$V_{\text{IL}}$	Input LOW Voltage <sup>[1]</sup>		-0.5	0.8	-0.5	0.8	-0.5	0.8	V
$I_{\text{IX}}$	Input Load Current	$\text{GND} \leq V_{\text{I}} \leq V_{\text{CC}}$	-1	+1	-1	+1	-1	+1	$\mu\text{A}$
$I_{\text{OZ}}$	Output Leakage Current	$\text{GND} \leq V_{\text{OUT}} \leq V_{\text{CC}}$ , Output Disabled	-1	+1	-1	+1	-1	+1	$\mu\text{A}$
$I_{\text{CC}}$	$V_{\text{CC}}$ Operating Supply Current	$V_{\text{CC}} = \text{Max.}$ , $f = f_{\text{MAX}} = 1/t_{\text{RC}}$		150		140		130	mA
$I_{\text{SB1}}$	Automatic CE Power-Down Current —TTL Inputs	$\text{Max. } V_{\text{CC}}, \bar{C}\bar{E} \geq V_{\text{IH}}$ $V_{\text{IN}} \geq V_{\text{IH}}$ or $V_{\text{IN}} \leq V_{\text{IL}}, f = f_{\text{MAX}}$		30		30		30	mA
$I_{\text{SB2}}$	Automatic CE Power-Down Current —CMOS Inputs	$\text{Max. } V_{\text{CC}},$ $\bar{C}\bar{E} \geq V_{\text{CC}} - 0.3\text{V}$ , $V_{\text{IN}} \geq V_{\text{CC}} - 0.3\text{V}$ , or $V_{\text{IN}} \leq 0.3\text{V}, f=0$	Com'l/Ind'l		8		8		mA
			Com'l	L		0.5		0.5	

Shaded areas contain preliminary information.

### Notes:

1.  $V_{\text{IL}}$  (min.) =  $-2.0\text{V}$  for pulse durations of less than 20 ns.

2.  $T_A$  is the "Instant On" case temperature.

**Electrical Characteristics** Over the Operating Range (continued)

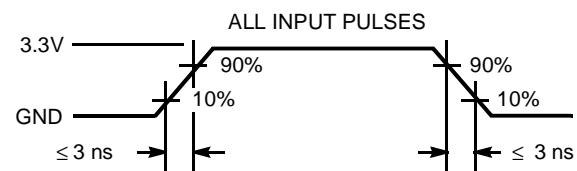
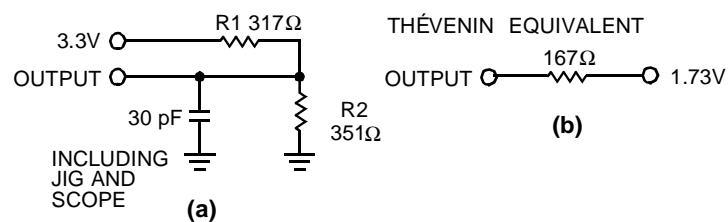
Parameter	Description	Test Conditions	7C1049V33-20		7C1049V33-25		Unit
			Min.	Max.	Min.	Max.	
$V_{OH}$	Output HIGH Voltage	$V_{CC} = \text{Min.}$ , $I_{OH} = -4.0 \text{ mA}$	2.4		2.4		V
$V_{OL}$	Output LOW Voltage	$V_{CC} = \text{Min.}$ , $I_{OL} = 8.0 \text{ mA}$		0.4		0.4	V
$V_{IH}$	Input HIGH Voltage		2.2	$V_{CC} + 0.5$	2.2	$V_{CC} + 0.5$	V
$V_{IL}$	Input LOW Voltage <sup>[1]</sup>		-0.5	0.8	-0.5	0.8	V
$I_{IX}$	Input Load Current	$GND \leq V_I \leq V_{CC}$	-1	+1	-1	+1	$\mu A$
$I_{OZ}$	Output Leakage Current	$GND \leq V_{OUT} \leq V_{CC}$ , Output Disabled	-1	+1	-1	+1	$\mu A$
$I_{CC}$	$V_{CC}$ Operating Supply Current	$V_{CC} = \text{Max.}$ , $f = f_{MAX} = 1/t_{RC}$		120		110	mA
$I_{SB1}$	Automatic CE Power-Down Current —TTL Inputs	$\text{Max. } V_{CC}, \overline{CE} \geq V_{IH}$ $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}, f = f_{MAX}$		30		30	mA
$I_{SB2}$	Automatic CE Power-Down Current —CMOS Inputs	Max. $V_{CC}$ , $\overline{CE} \geq V_{CC} - 0.3V$ , $V_{IN} \geq V_{CC} - 0.3V$ , or $V_{IN} \leq 0.3V, f=0$	Com'l/Ind'l		8		mA
			Com'l L		0.5		0.5 mA

**Capacitance<sup>[3]</sup>**

Parameter	Description	Test Conditions	Max.	Unit
$C_{IN}$	Input Capacitance	$T_A = 25^\circ C, f = 1 \text{ MHz}$ , $V_{CC} = 3.3V$	8	pF
$C_{OUT}$	I/O Capacitance		8	pF

**Note:**

3. Tested initially and after any design or process changes that may affect these parameters.

**AC Test Loads and Waveforms**


1049V33-3

1049V33-4

**Switching Characteristics<sup>[5]</sup> Over the Operating Range**

Parameter	Description	7C1049V33-12		7C1049V33-15		7C1049V33-17		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>READ CYCLE</b>								
$t_{RC}$	Read Cycle Time	12		15		17		ns
$t_{AA}$	Address to Data Valid		12		15		17	ns
$t_{OHA}$	Data Hold from Address Change	3		3		3		ns
$t_{ACE}$	$\overline{CE}$ LOW to Data Valid		12		15		17	ns
$t_{DOE}$	$\overline{OE}$ LOW to Data Valid		6		7		8	ns
$t_{LZOE}$	$\overline{OE}$ LOW to Low Z	0		0		0		ns
$t_{HZOE}$	$\overline{OE}$ HIGH to High Z <sup>[5, 6]</sup>		6		7		8	ns
$t_{LZCE}$	$\overline{CE}$ LOW to Low Z <sup>[6]</sup>	3		3		3		ns
$t_{HZCE}$	$\overline{CE}$ HIGH to High Z <sup>[5, 6]</sup>		6		7		8	ns
$t_{PU}$	$\overline{CE}$ LOW to Power-Up	0		0		0		ns
$t_{PD}$	$\overline{CE}$ HIGH to Power-Down		12		15		17	ns
<b>WRITE CYCLE<sup>[7, 8]</sup></b>								
$t_{WC}$	Write Cycle Time	12		15		17		ns
$t_{SCE}$	$\overline{CE}$ LOW to Write End	10		12		13		ns
$t_{AW}$	Address Set-Up to Write End	10		12		13		ns
$t_{HA}$	Address Hold from Write End	0		0		0		ns
$t_{SA}$	Address Set-Up to Write Start	0		0		0		ns
$t_{PWE}$	$\overline{WE}$ Pulse Width	10		12		13		ns
$t_{SD}$	Data Set-Up to Write End	7		8		9		ns
$t_{HD}$	Data Hold from Write End	0		0		0		ns
$t_{LZWE}$	$\overline{WE}$ HIGH to Low Z <sup>[6]</sup>	3		3		3		ns
$t_{HZWE}$	$\overline{WE}$ LOW to High Z <sup>[5, 6]</sup>		6		7		8	ns

Shaded areas contain preliminary information.

**Notes:**

4. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified  $I_{OL}/I_{OH}$  and 30-pF load capacitance.
5.  $t_{HZOE}$ ,  $t_{HZCE}$ , and  $t_{HZWE}$  are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured  $\pm 500$  mV from steady-state voltage.
6. At any given temperature and voltage condition,  $t_{HZCE}$  is less than  $t_{LZCE}$ ,  $t_{HZOE}$  is less than  $t_{LZOE}$ , and  $t_{HZWE}$  is less than  $t_{LZWE}$  for any given device.
7. The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW, and  $\overline{WE}$  LOW.  $\overline{CE}$  and  $\overline{WE}$  must be LOW to initiate a write, and the transition of either of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.
8. The minimum write cycle time for Write Cycle no. 3 ( $\overline{WE}$  controlled,  $\overline{OE}$  LOW) is the sum of  $t_{HZWE}$  and  $t_{SD}$ .

**Switching Characteristics<sup>[5]</sup>** Over the Operating Range (continued)

Parameter	Description	7C1049V33-20		7C1049V33-25		Unit
		Min.	Max.	Min.	Max.	
<b>READ CYCLE</b>						
$t_{RC}$	Read Cycle Time	20		25		ns
$t_{AA}$	Address to Data Valid		20		25	ns
$t_{OHA}$	Data Hold from Address Change	3		5		ns
$t_{ACE}$	$\overline{CE}$ LOW to Data Valid		20		25	ns
$t_{DOE}$	$\overline{OE}$ LOW to Data Valid		8		10	ns
$t_{LZOE}$	$\overline{OE}$ LOW to Low Z	0		0		ns
$t_{HZOE}$	$\overline{OE}$ HIGH to High Z <sup>[5, 6]</sup>		8		10	ns
$t_{LZCE}$	$\overline{CE}$ LOW to Low Z <sup>[6]</sup>	3		5		ns
$t_{HZCE}$	$\overline{CE}$ HIGH to High Z <sup>[5, 6]</sup>		8		10	ns
$t_{PU}$	$\overline{CE}$ LOW to Power-Up	0		0		ns
$t_{PD}$	$\overline{CE}$ HIGH to Power-Down		20		25	ns
<b>WRITE CYCLE<sup>[7]</sup></b>						
$t_{WC}$	Write Cycle Time	20		25		ns
$t_{SCE}$	$\overline{CE}$ LOW to Write End	13		15		ns
$t_{AW}$	Address Set-Up to Write End	13		15		ns
$t_{HA}$	Address Hold from Write End	0		0		ns
$t_{SA}$	Address Set-Up to Write Start	0		0		ns
$t_{PWE}$	$\overline{WE}$ Pulse Width	13		15		ns
$t_{SD}$	Data Set-Up to Write End	9		10		ns
$t_{HD}$	Data Hold from Write End	0		0		ns
$t_{LZWE}$	$\overline{WE}$ HIGH to Low Z <sup>[6]</sup>	3		5		ns
$t_{HZWE}$	$\overline{WE}$ LOW to High Z <sup>[5, 6]</sup>		8		10	ns

**Data Retention Characteristics** Over the Operating Range (For L version only)

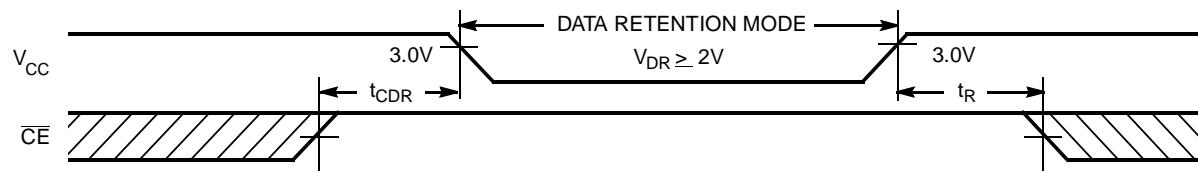
Parameter	Description	Conditions <sup>[10]</sup>	Min.	Max	Unit
$V_{DR}$	$V_{CC}$ for Data Retention		2.0		V
$I_{CCDR}$	Data Retention Current	$V_{CC} = V_{DR} = 2.0V$ , $\overline{CE} \geq V_{CC} - 0.3V$ $V_{IN} \geq V_{CC} - 0.3V$ or $V_{IN} \leq 0.3V$		330	$\mu A$
$t_{CDR}^{[3]}$	Chip Deselect to Data Retention Time		0		ns
$t_R^{[9]}$	Operation Recovery Time		$t_{RC}$		ns

**Notes:**

9.  $t_r \leq 3$  ns for the -12 and -15 speeds.  $t_r \leq 5$  ns for the -20 ns and slower speeds.

10. No input may exceed  $V_{CC} + 0.5V$ .

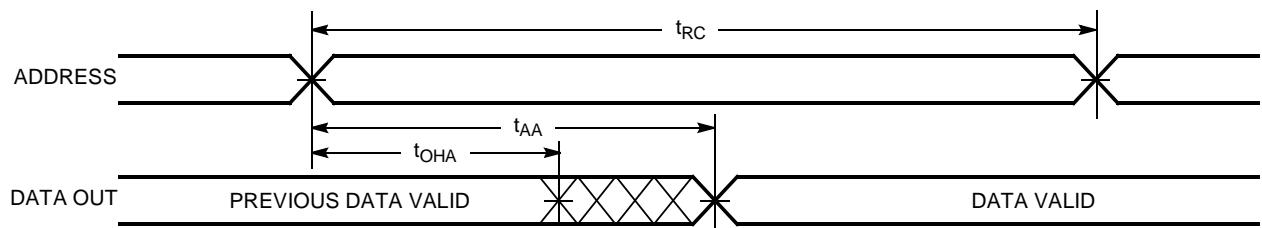
## Data Retention Waveform



1049V33-5

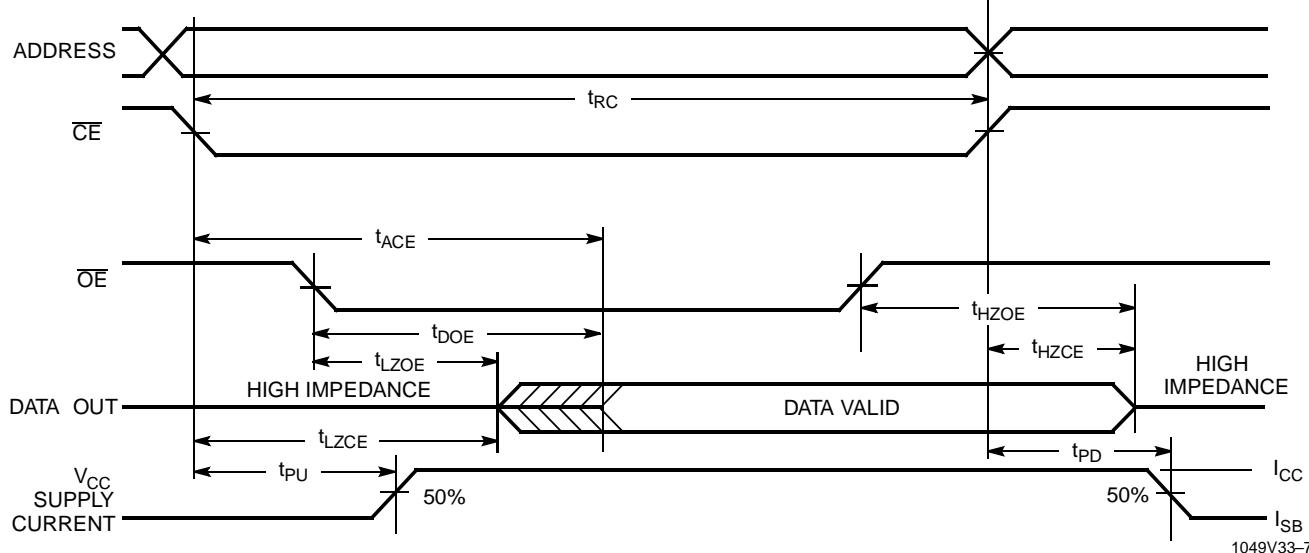
## Switching Waveforms

### Read Cycle No. 1<sup>[11, 12]</sup>



1049V33-6

### Read Cycle No. 2 ( $\overline{OE}$ Controlled)<sup>[12, 13]</sup>

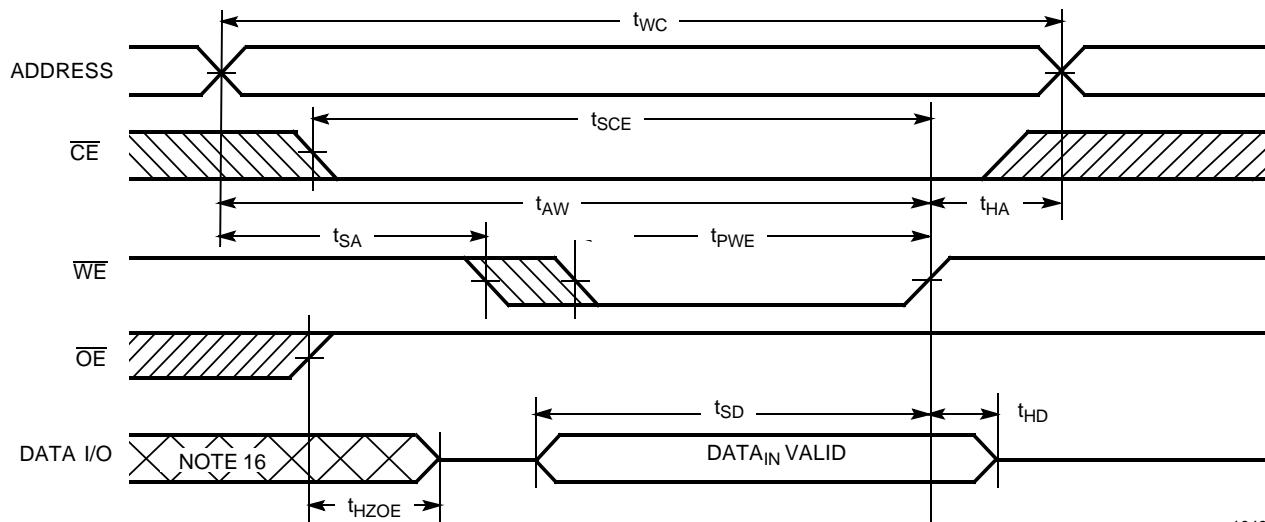


#### Notes:

11. Device is continuously selected.  $\overline{OE}, \overline{CE} = V_{IL}$ .
12.  $\overline{WE}$  is HIGH for read cycle.
13. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

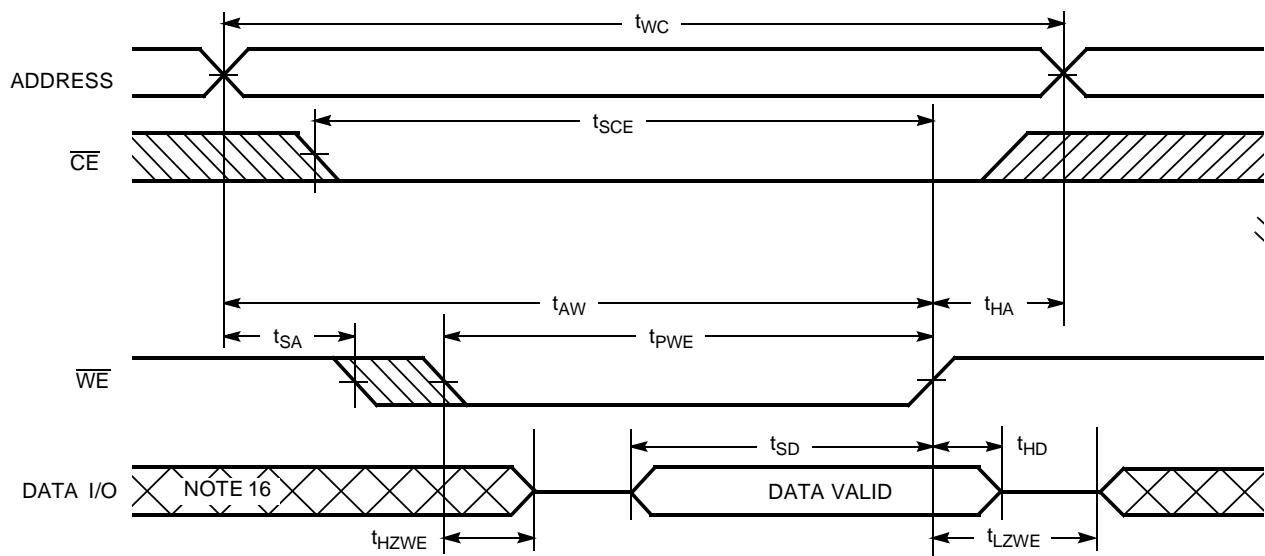
### Switching Waveforms (continued)

#### Write Cycle No. 1 ( $\overline{WE}$ Controlled, $\overline{OE}$ HIGH During Write)<sup>[14, 15]</sup>



1049V33-8

#### Write Cycle No. 2 ( $\overline{WE}$ Controlled, $\overline{OE}$ LOW)



1049V33-9

#### Notes:

14. Data I/O is high impedance if  $\overline{OE} = V_{IH}$ .
15. If  $\overline{CE}$  goes HIGH simultaneously with  $\overline{WE}$  going HIGH, the output remains in a high-impedance state.
16. During this period the I/Os are in the output state and input signals should not be applied.

### Truth Table

$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$I/O_0 - I/O_7$	Mode	Power
H	X	X	High Z	Power-Down	Standby ( $I_{SB}$ )
L	L	H	Data Out	Read	Active ( $I_{CC}$ )
L	X	L	Data In	Write	Active ( $I_{CC}$ )
L	H	H	High Z	Selected, Outputs Disabled	Active ( $I_{CC}$ )

## Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1049V33-12VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049V33L-12VC	V36	36-Lead (400-Mil) Molded SOJ	
15	CY7C1049V33-15VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049V33L-15VC	V36	36-Lead (400-Mil) Molded SOJ	
17	CY7C1049V33-17VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049V33L-17VC	V36	36-Lead (400-Mil) Molded SOJ	
20	CY7C1049V33-20VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049V33L-20VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049V33-20VI	V36	36-Lead (400-Mil) Molded SOJ	
25	CY7C1049V33-25VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049V33-25VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial

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## Package Diagram

**36-Lead (400-Mil) Molded SOJ V36**

